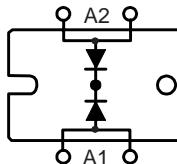


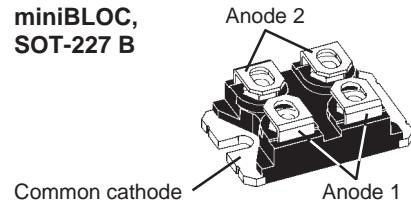
# HiPerFRED™ Epitaxial Diode with soft recovery

## Non isolated

$V_{RSM}$ V	$V_{RRM}$ V	Type
600	600	DSEC 240-06A



$I_{FAV} = 2 \times 120 \text{ A}$   
 $V_{RRM} = 600 \text{ V}$   
 $t_{rr} = 35 \text{ ns}$



Symbol	Conditions	Maximum Ratings	
$I_{FRMS}$		200	A
$I_{FAVM}$	$T_C = 105^\circ\text{C}$ ; rectangular, $d = 0.5$	120	A
$I_{FSM}$	$T_{VJ} = 45^\circ\text{C}$ ; $t_p = 10 \text{ ms}$ (50 Hz), sine	2000	A
$E_{AS}$	$T_{VJ} = 25^\circ\text{C}$ ; non-repetitive $I_{AS} = 3 \text{ A}$ ; $L = 180 \mu\text{H}$	0.8	mJ
$I_{AR}$	$V_A = 1.5 \cdot V_R$ typ.; $f = 10 \text{ kHz}$ ; repetitive	0.3	A
$T_{VJ}$		-40...+150	°C
$T_{VJM}$		150	°C
$T_{stg}$		-40...+150	°C
$P_{tot}$	$T_C = 25^\circ\text{C}$	620	W
$M_d$	mounting torque (M4) terminal connection torque (M4)	1.1-1.5/9-13 1.1-1.5/9-13	Nm/lb.in. Nm/lb.in.
Weight	typical	30	g

Symbol	Conditions	Characteristic Values	
		typ.	max.
$I_R$ ①	$V_R = V_{RRM}$ ; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 150^\circ\text{C}$	2 8	mA mA
$V_F$ ②	$I_F = 120 \text{ A}$ ; $T_{VJ} = 125^\circ\text{C}$ $T_{VJ} = 25^\circ\text{C}$	1.39 1.91	V V
$R_{thJC}$ $R_{thCH}$	with heatsink compound	0.15	K/W K/W
$t_{rr}$	$I_F = 1 \text{ A}$ ; $-di/dt = 400 \text{ A}/\mu\text{s}$ $V_R = 30 \text{ V}$ ; $T_{VJ} = 25^\circ\text{C}$	35	ns
$I_{RM}$	$I_F = 400 \text{ A}$ ; $-di_F/dt = 200 \text{ A}/\mu\text{s}$ $V_R = 100 \text{ V}$ ; $T_{VJ} = 100^\circ\text{C}$	8	10.2 A

Pulse test: ① Pulse Width = 5 ms, Duty Cycle < 2.0 %  
 ② Pulse Width = 300  $\mu\text{s}$ , Duty Cycle < 2.0 %

Data according to IEC 60747 and per diode unless otherwise specified

IXYS reserves the right to change limits, test conditions and dimensions.